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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon PNP Triple Diffused

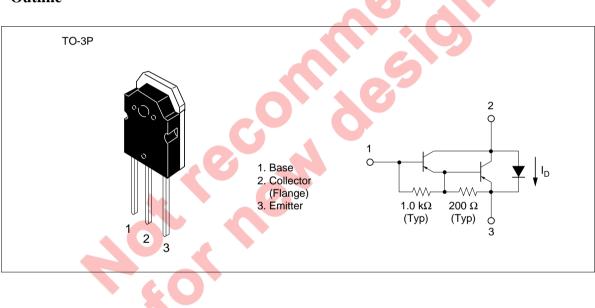


ADE-208-865 (Z) 1st. Edition September 2000

Application

Power switching complementary pair with 2SD1436(K)

Outline



Absolute Maximum Ratings (Ta = 25°C)

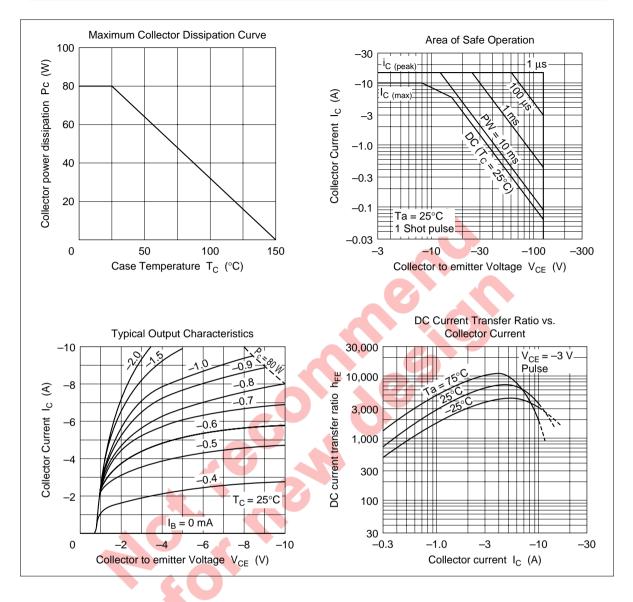
Item	Symbol	Rating	Unit			
Collector to base voltage	V _{CBO}	-120	V			
Collector to emitter voltage	V _{CEO}	-120	V			
Emitter to base voltage	V _{EBO}	-7	V			
Collector current	I _c	-10	A			
Collector peak current	I _{C(peak)}	-15	A			
C to E diode forward current	l_*1	10	A			
Collector power dissipation	P _c * ¹	80	W			
Junction temperature	Tj	150	°C			
Storage temperature	Tstg	-55 to +150	°C			
Note: 1. Value at $T_c = 25^{\circ}C$ Electrical Characteristics (Ta = 25°C)						

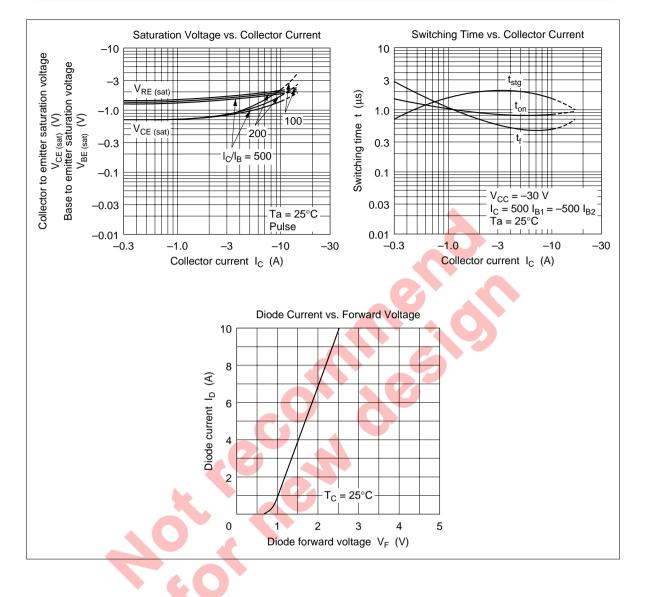
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-120		2	V	$I_{\rm C}$ = -25 mA, $R_{\rm BE}$ = ∞
Emitter to base breakdown voltage	V _{(BR)EBO}	-7	-	9	V	$I_{\rm E} = -200$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	—	-	-100	μA	$V_{CB} = -120 \text{ V}, \text{ I}_{E} = 0$
	I _{CEO}	-	-	-10	μΑ	$V_{ce} = -100 \text{ V}, \text{ R}_{be} = \infty$
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{ce} = -3 \text{ V}, \text{ I}_{c} = -5 \text{ A}^{*1}$
Collector to emitter saturation	V _{CE(sat)1}	-	_	-1.5	V	$I_{\rm c} = -5 \text{ A}, I_{\rm B} = -10 \text{ mA}^{*1}$
voltage	V _{CE(sat)2}		_	-3.0	V	$I_{\rm C} = -10$ A, $I_{\rm B} = -0.1$ A ^{*1}
Base to emitter saturation	V _{BE(sat)1}	—	_	-2.0	V	$I_{\rm c} = -5 \text{ A}, I_{\rm B} = -10 \text{ mA}^{*1}$
voltage	V _{BE(sat)2}	—	_	-3.5	V	$I_{\rm c} = -10$ A, $I_{\rm B} = -0.1$ A ^{*1}
C to E diode forward voltage	VD	—	_	3.0	V	$I_{D} = 10 \text{ A}^{*1}$
Turn on time	t _{on}	—	0.8	—	μs	$V_{cc} = -30 V,$
Turn off time	t _{off}	_	4.0	_	μs	$I_{\rm C} = -5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = -10 \text{ mA}$

Note: 1. Pulse test

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